

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

Passivated sensitive gate thyristor in a SOT54 plastic package.

### 1.2 Features

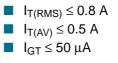
Designed to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits

#### **1.3 Applications**

General purpose switching and phase control

#### 1.4 Quick reference data

- $\blacksquare V_{DRM} \le 400 V$
- $V_{RRM} \le 400 V$
- $\blacksquare I_{TSM} \le 8 \text{ A}$



### 2. Pinning information

Pin	Description	Simplified outline	Symbol
1	anode (A)		
2	gate (G)		А Ӈ К
3	cathode (K)		G sym037
		SOT54 (TO-92)	



### 3. Ordering information

Table 2. Ordering information					
Type number	Package				
	Name	Description	Version		
BT169D-L	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54		

### 4. Limiting values

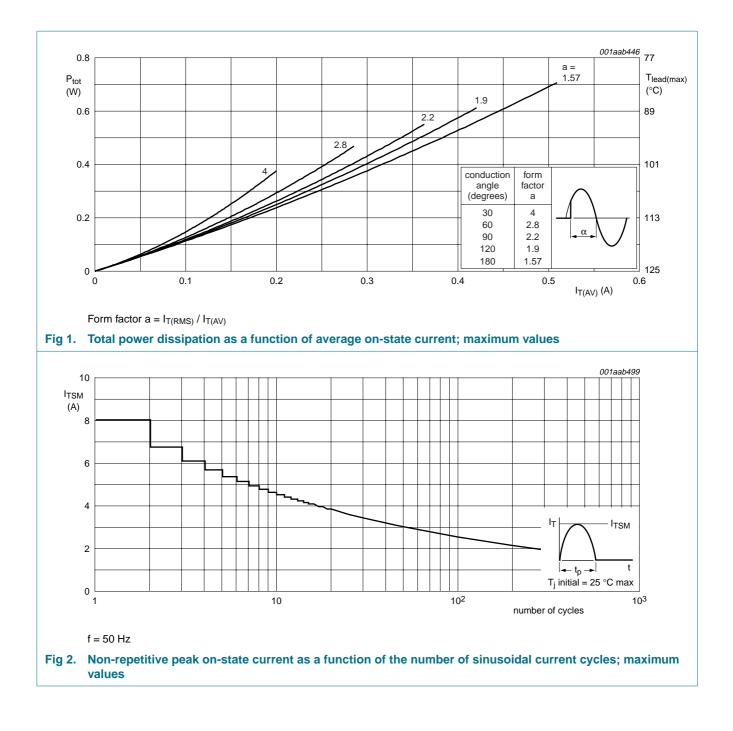
#### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage		<u>[1]</u> -	400	V
V <sub>RRM</sub>	repetitive peak reverse voltage		<u>[1]</u> _	400	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; see <u>Figure 1</u>	-	0.5	A
I <sub>T(RMS)</sub>	RMS on-state current	all conduction angles; see Figure 4 and $\frac{5}{2}$	-	0.8	A
I <sub>TSM</sub>	non-repetitive peak on-state current	half sine wave; $T_j = 25 \text{ °C}$ prior to surge; see Figure 2 and 3			
		t = 10 ms	-	8	А
		t = 8.3 ms	-	9	А
l <sup>2</sup> t	l <sup>2</sup> t for fusing	t = 10 ms	-	0.32	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	$I_{TM}$ = 2 A; $I_G$ = 10 mA; $dI_G/dt$ = 100 mA/µs	-	50	A/μs
I <sub>GM</sub>	peak gate current		-	1	А
V <sub>GM</sub>	peak gate voltage		-	5	V
V <sub>RGM</sub>	peak reverse gate voltage		-	5	V
P <sub>GM</sub>	peak gate power		-	2	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-	0.1	W
T <sub>stg</sub>	storage temperature		-40	+150	°C
Тj	junction temperature		-	125	°C

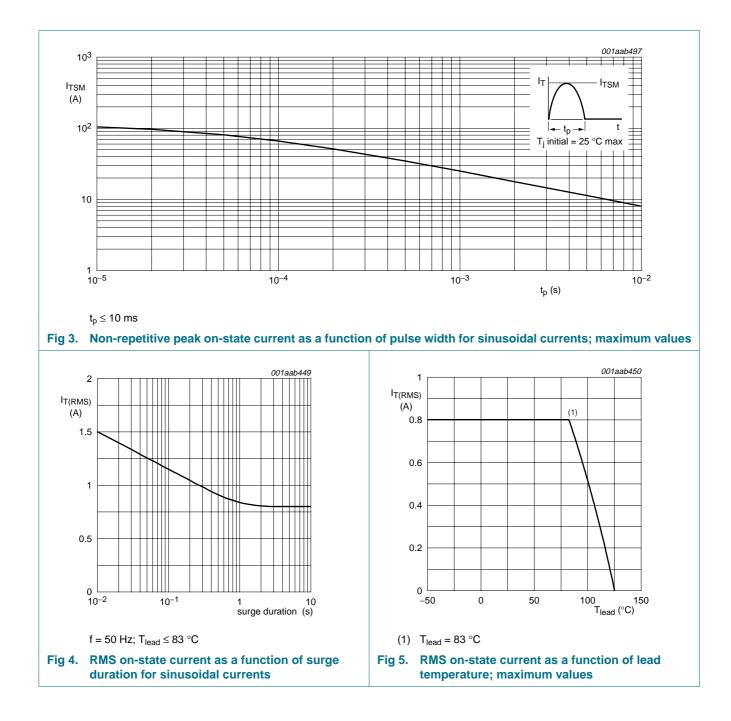
[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

### BT169D-L Thyristor, logic level



# BT169D-L

Thyristor, logic level



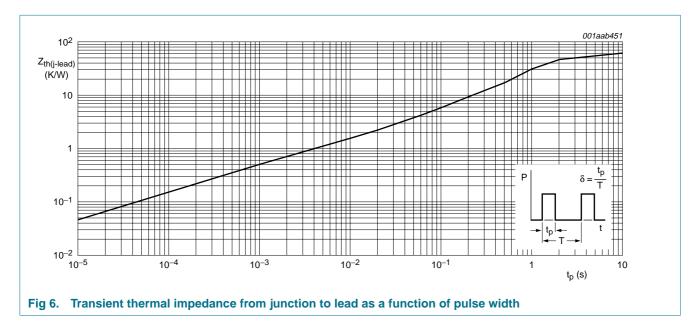
Table

Thyristor, logic level

### 5. Thermal characteristics

at all and a fault of a

Table 4.	I nermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	see Figure 6	-	-	60	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	Printed-circuit board mounted; lead length = 4 mm	-	150	-	K/W

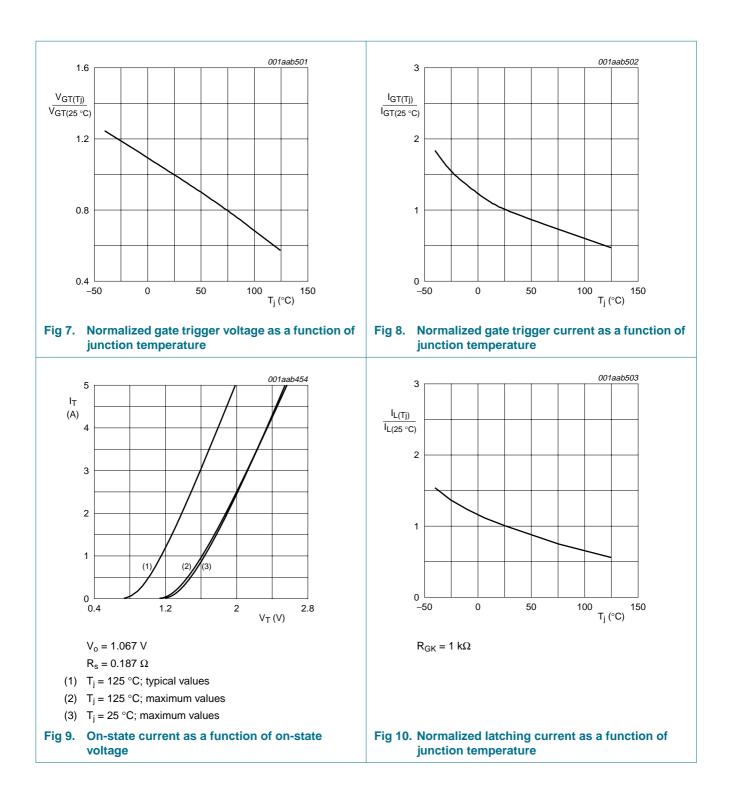


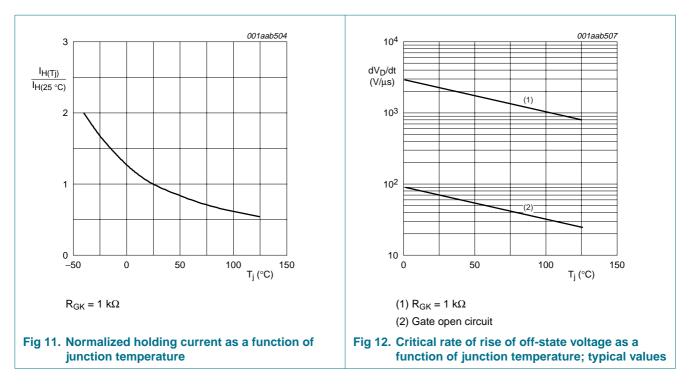
Thyristor, logic level

### 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static cha	racteristics					
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA};$ gate open circuit; see Figure 8	-	-	50	μA
IL	latching current	$V_D$ = 12 V; $I_{GT}$ = 0.5 mA; $R_{GK}$ = 1 k $\Omega$ ; see Figure 10	-	2	6	mA
I <sub>H</sub>	holding current	$V_D$ = 12 V; $I_{GT}$ = 0.5 mA; $R_{GK}$ = 1 k\Omega; see $\underline{Figure~11}$	-	2	5	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.2 A	-	1.25	1.7	V
V <sub>GT</sub>	gate trigger voltage	$I_T = 10 \text{ mA}$ ; gate open circuit; see Figure 7				
		V <sub>D</sub> = 12 V	-	0.5	0.8	V
		$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	0.2	0.3	-	V
I <sub>D</sub>	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^\circ C;$ $R_{GK} = 1 \ k\Omega$	-	0.05	0.1	mA
Dynamic o	haracteristics					
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM} = 0.67 \times V_{DRM(max)}$ ; $T_j = 125 \text{ °C}$ ; exponential waveform; see Figure 12				
		$R_{GK} = 1 \ k\Omega$	500	800	-	V/μs
		gate open circuit	-	25	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$\begin{split} I_{TM} = 2 \text{ A};  V_D =  V_{DRM(max)};  I_G = 10  \text{mA}; \\ \text{d}I_G/\text{d}t = 0.1  \text{A}/\mu\text{s} \end{split}$	-	2	-	μs
t <sub>q</sub>	commutated turn-off time	$ \begin{split} &V_{DM} = 0.67 \times V_{DRM(max)}; \ T_{j} = 125 \ ^{\circ}C; \\ &I_{TM} = 1.6 \ A; \ V_{R} = 35 \ V; \\ &(dI_{T}/dt)_{M} = 30 \ A/\mu s; \ dV_{D}/dt = 2 \ V/\mu s; \\ &R_{GK} = 1 \ k\Omega \end{split} $	-	100	-	μs

### BT169D-L Thyristor, logic level





### 7. Package information

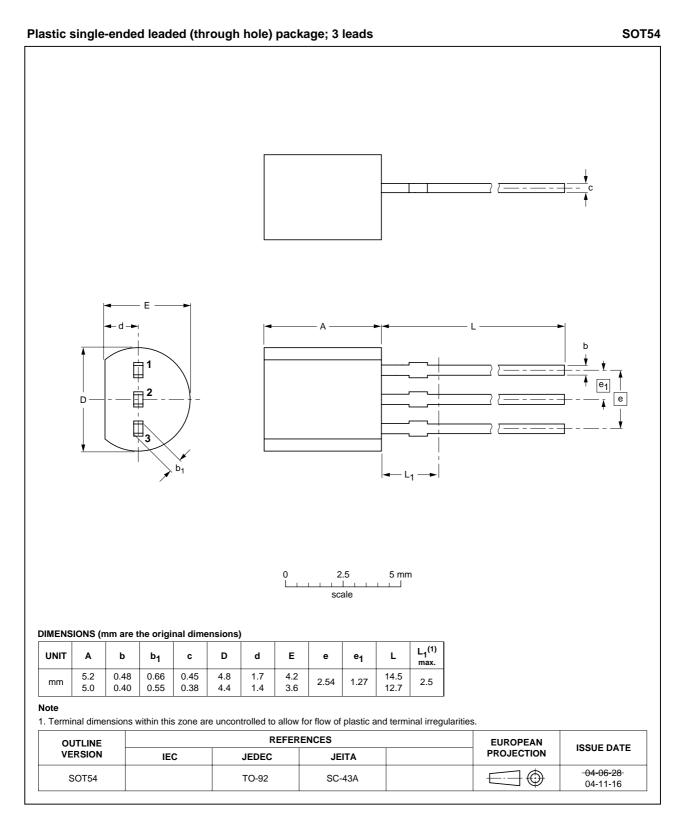
Epoxy meets requirements of UL 94 V-0 at 3.175 mm

**BT169D-L** 

**Thyristor, logic level** 

BT169D-L Thyristor, logic level

### 8. Package outline



#### Fig 13. Package outline SOT54 (TO-92) BT169D-L\_1

Thyristor, logic level

### 9. Revision history

Table 6. Rev	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BT169D-L_1	20071112	Product data sheet	-	-	

### **10. Legal information**

#### **10.1** Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### **10.2 Definitions**

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

#### **10.3 Disclaimers**

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

#### 10.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

### **11. Contact information**

For additional information, please visit: http://www.nxp.com

For sales office addresses, send an email to: salesaddresses@nxp.com

## BT169D-L

Thyristor, logic level

### 12. Contents

1	Product profile 1
1.1	General description
1.2	Features
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 1
3	Ordering information 2
4	Limiting values 2
5	Thermal characteristics 5
6	Characteristics
7	Package information 8
8	Package outline 9
9	Revision history 10
10	Legal information
10.1	Data sheet status 11
10.2	Definitions 11
10.3	Disclaimers
10.4	Trademarks 11
11	Contact information 11
12	Contents 12

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2007.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 12 November 2007 Document identifier: BT169D-L\_1

